



# 10NM65-U2

Power MOSFET

## 10A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

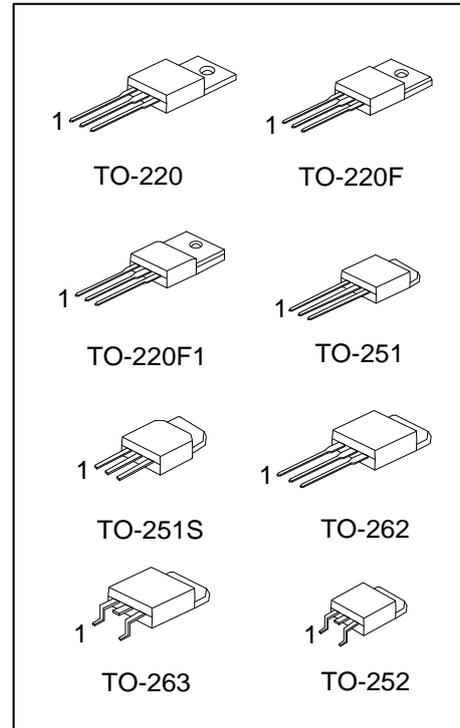
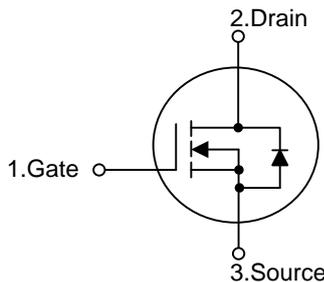
### DESCRIPTION

The UTC 10NM65-U2 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

### FEATURES

- \*  $R_{DS(ON)} \leq 0.58\Omega$  @  $V_{GS}=10V, I_D=5.0A$
- \* By using Super Junction Structure
- \* Fast Switching
- \* With 100% Avalanche Tested

### SYMBOL



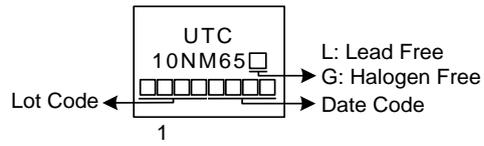
### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
10NM65L-TA3-T	10NM65G-TA3-T	TO-220	G	D	S	Tube
10NM65L-TF3-T	10NM65G-TF3-T	TO-220F	G	D	S	Tube
10NM65L-TF1-T	10NM65G-TF1-T	TO-220F1	G	D	S	Tube
10NM65L-TM3-T	10NM65G-TM3-T	TO-251	G	D	S	Tube
10NM65L-TMS-T	10NM65G-TMS-T	TO-251S	G	D	S	Tube
10NM65L-TN3-R	10NM65G-TN3-R	TO-252	G	D	S	Tape Reel
10NM65L-T2Q-T	10NM65G-T2Q-T	TO-262	G	D	S	Tube
10NM65L-TQ2-T	10NM65G-TQ2-T	TO-263	G	D	S	Tube
10NM65L-TQ2-R	10NM65G-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>10NM65G-TA3-T</p> <p>(1) Packing Type</p> <p>(2) Package Type</p> <p>(3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F, TM3: TO-251, TMS: TO-251S, TN3: TO-252, T2Q: TO-262, TQ2: TO-263</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p>
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## MARKING



### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	650	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Drain Current	Continuous	I <sub>D</sub>	10	A
	Pulsed (Note 2)	I <sub>DM</sub>	20	A
Avalanche Current (Note 2)		I <sub>AR</sub>	1.9	A
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	312	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	5.6	V/ns
Power Dissipation	TO-220/TO-262/TO-263	P <sub>D</sub>	78	W
	TO-220F/TO-220F1		25	W
	TO-251/TO-251S		52	W
	TO-252			
Junction Temperature		T <sub>J</sub>	+150	°C
Storage Temperature Range		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. L=100mH, I<sub>AS</sub>=2.5A, V<sub>DD</sub>= 50V, R<sub>G</sub>=25Ω, Starting T<sub>J</sub>=25°C

4. I<sub>SD</sub> ≤10A, di/dt ≤200A/μs, V<sub>DD</sub> ≤BV<sub>DSS</sub>, Starting T<sub>J</sub>=25°C

### ■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-262 TO-263	θ <sub>JA</sub>	62.5	°C/W	
	TO-251/TO-251S TO-252		110		
	Junction to Case	TO-220/TO-262/TO-263	θ <sub>JC</sub>	1.6	°C/W
		TO-220F/TO-220F1		5.0	
TO-251/TO-251S		2.4 (Note)			
TO-252					

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ **ELECTRICAL CHARACTERISTICS** ( $T_J=25^{\circ}\text{C}$ , unless otherwise specified)

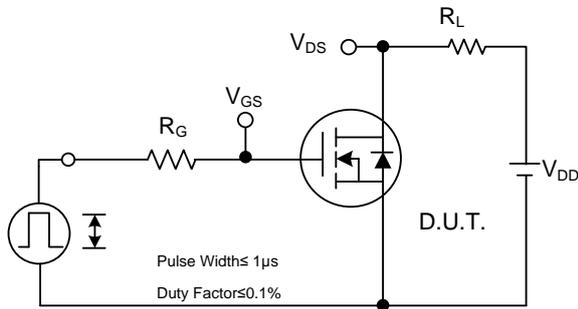
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
<b>OFF CHARACTERISTICS</b>							
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	650			V	
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$			10	$\mu A$	
Gate-Source Leakage Current	Forward	$V_{DS}=0V, V_{GS}=30V$			100	nA	
	Reverse		$V_{DS}=0V, V_{GS}=-30V$			-100	nA
<b>ON CHARACTERISTICS</b>							
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5		4.5	V	
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=5.0A$			0.58	$\Omega$	
<b>DYNAMIC PARAMETERS</b>							
Input Capacitance	$C_{ISS}$	$V_{GS}=0V, V_{DS}=25V, f=1.0\text{MHz}$		610		pF	
Output Capacitance	$C_{OSS}$				500		pF
Reverse Transfer Capacitance	$C_{RSS}$				40		pF
<b>SWITCHING PARAMETERS</b>							
Total Gate Charge (Note 1)	$Q_G$	$V_{DS}=520V, V_{GS}=10V, I_D=10A,$ $I_G=1\text{mA}$ (Note 1, 2)		27		nC	
Gate to Source Charge	$Q_{GS}$				9.2		nC
Gate to Drain Charge	$Q_{GD}$				7.5		nC
Turn-ON Delay Time (Note 1)	$t_{D(ON)}$	$V_{DD}=100V, V_{GS}=10V,$ $I_D=10A, R_G=25\Omega$ (Note 1, 2)		8		ns	
Rise Time	$t_R$				21		ns
Turn-OFF Delay Time	$t_{D(OFF)}$				63		ns
Fall-Time	$t_F$				36		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>							
Maximum Body-Diode Continuous Current	$I_S$				10	A	
Maximum Body-Diode Pulsed Current	$I_{SM}$				20	A	
Drain-Source Diode Forward Voltage (Note 1)	$V_{SD}$	$I_S=10A, V_{GS}=0V$			1.4	V	
Body Diode Reverse Recovery Time (Note 1)	$t_{rr}$	$I_S=10A, V_{GS}=0V,$ $dI_F/dt=100A/\mu s$		380		ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$				5		$\mu C$

Notes: 1. Pulse Test : Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .

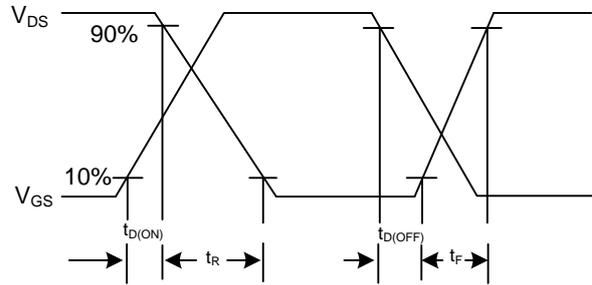
2. Essentially independent of operating temperature.



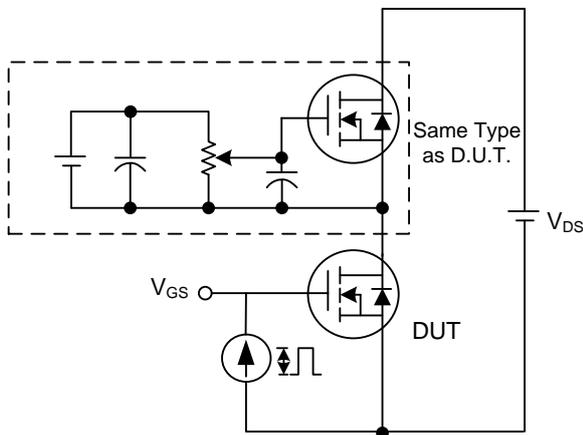
## TEST CIRCUITS AND WAVEFORMS



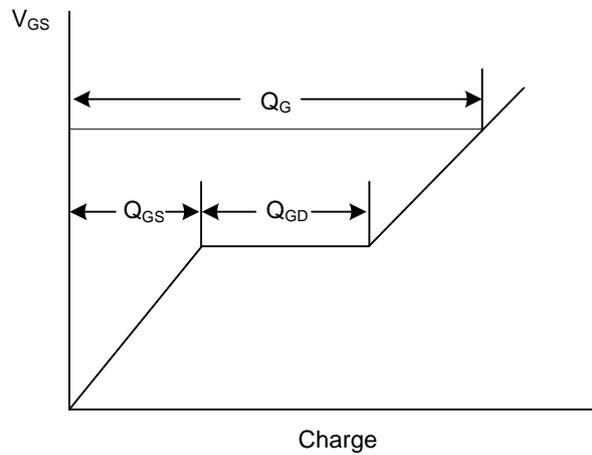
Switching Test Circuit



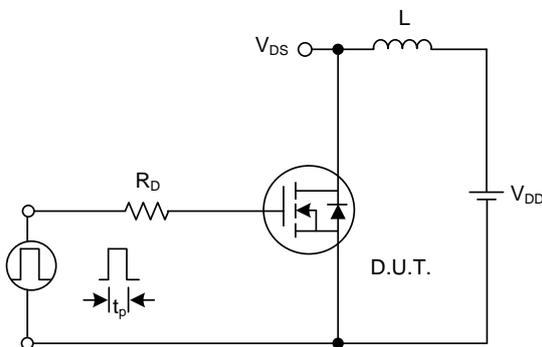
Switching Waveforms



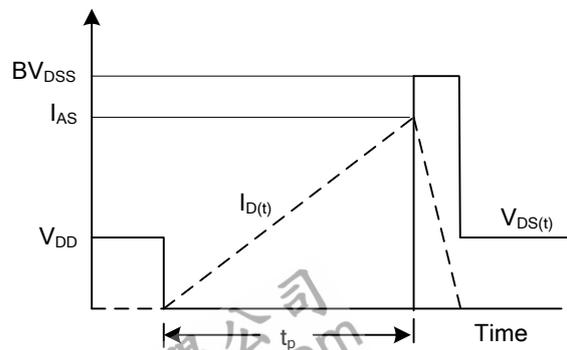
Gate Charge Test Circuit



Gate Charge Waveform

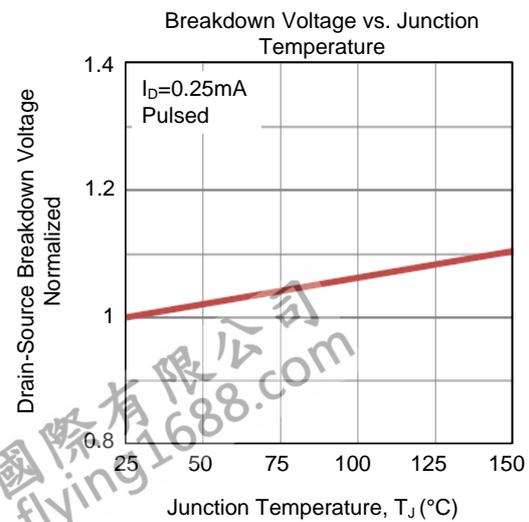
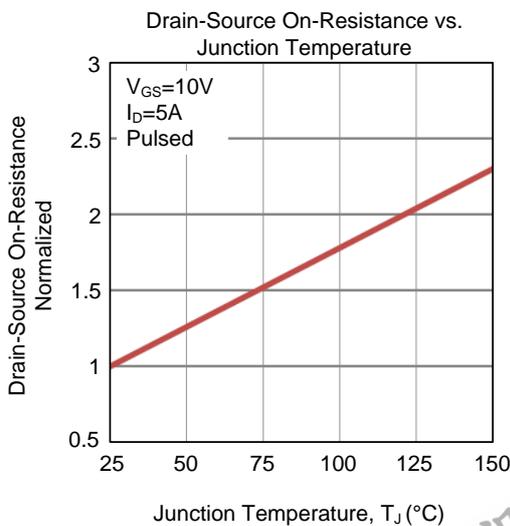
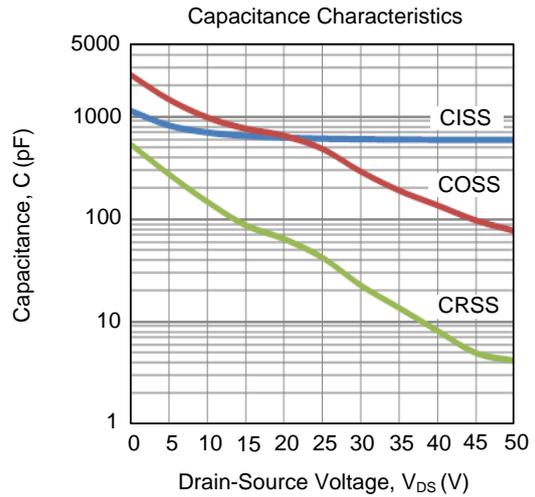
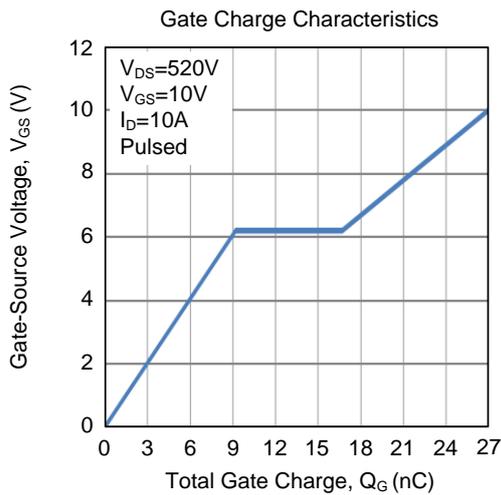
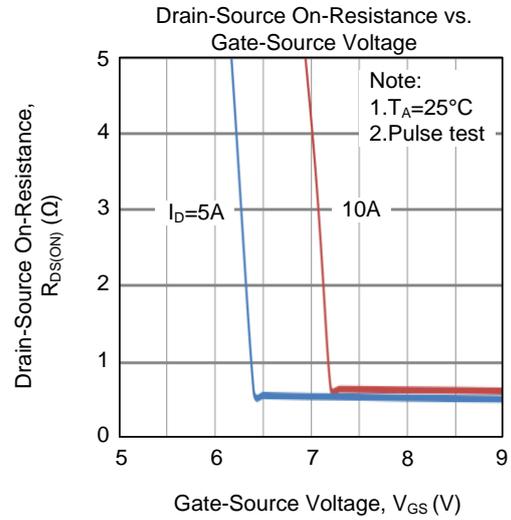
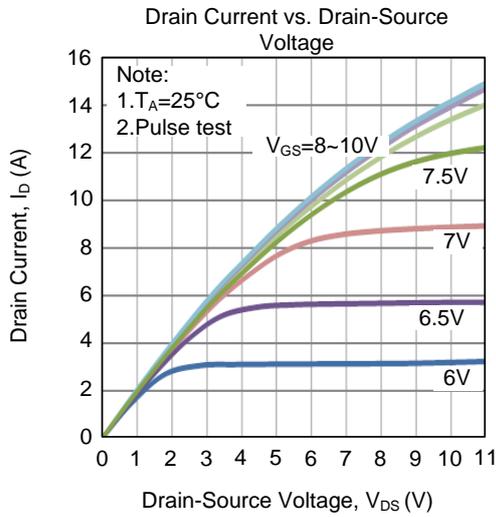


Unclamped Inductive Switching Test Circuit

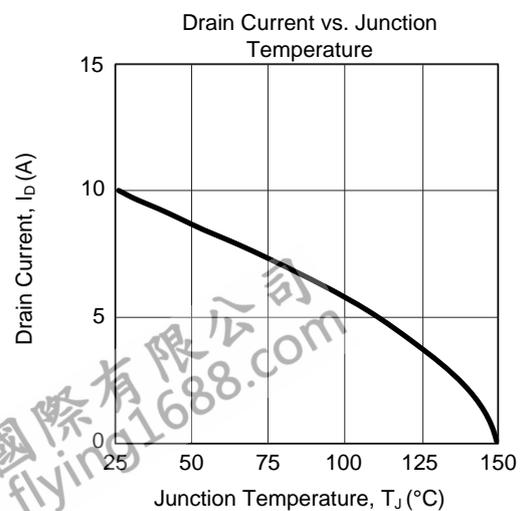
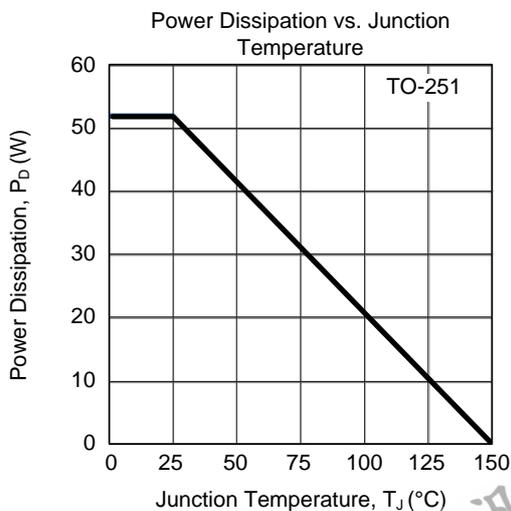
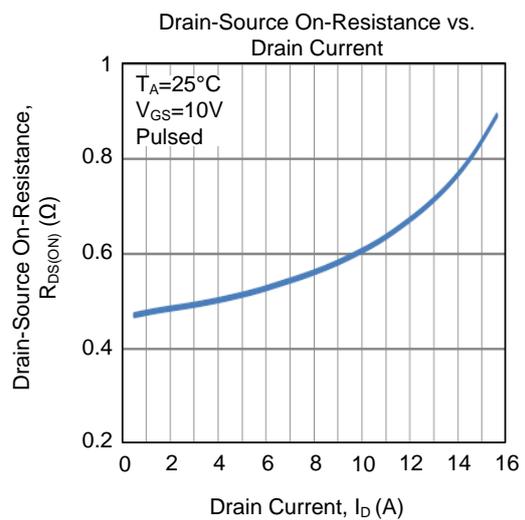
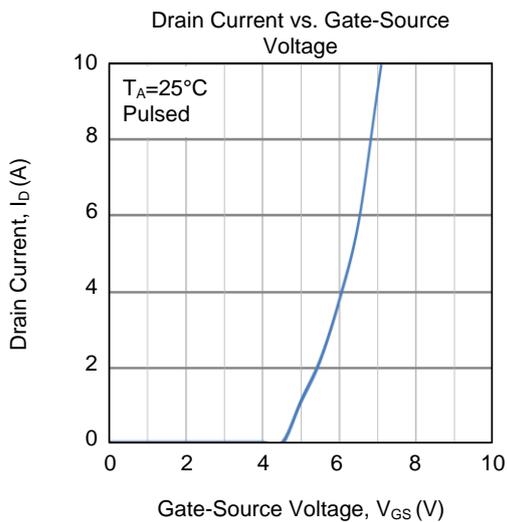
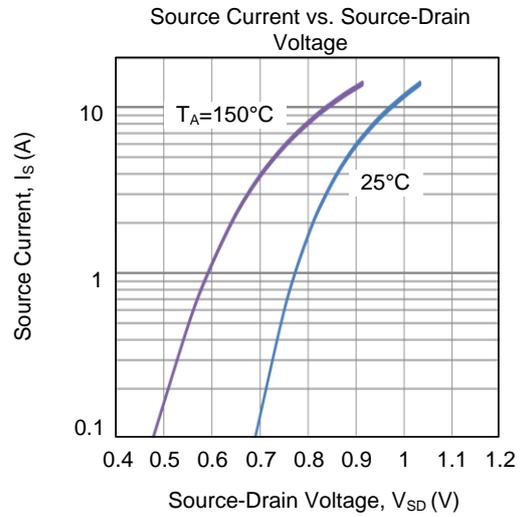
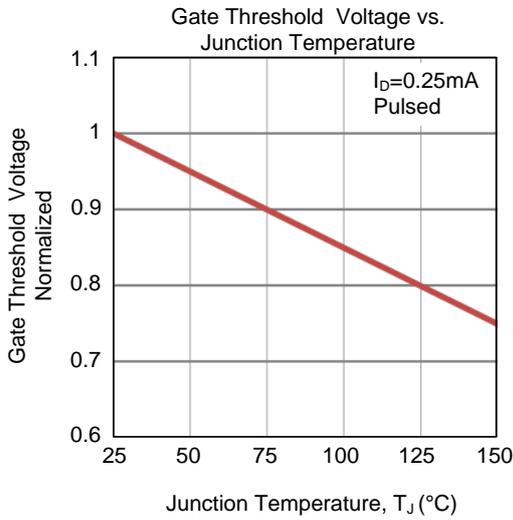


Unclamped Inductive Switching Waveforms

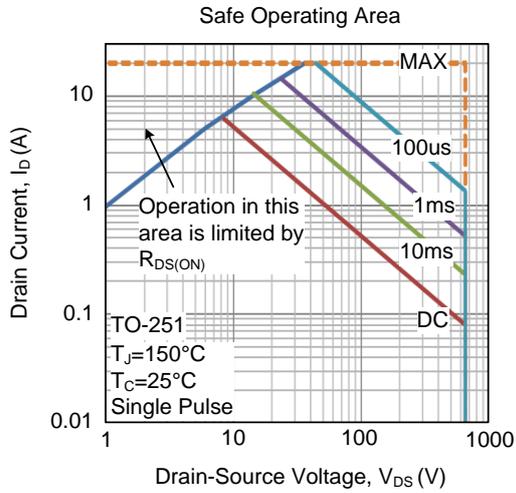
## TYPICAL CHARACTERISTICS



## TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



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